

General Description

The SY28637F device is a very small supervisory circuit that monitor voltage greater than 500mV with a 0.25% threshold accuracy and offer adjustable delay time using external capacitor. The SY28637F has a logic enable pin to power on and off the output.

The SY28637F operates from 1.7V to 6.5V and has a typical quiescent current of 9 μ A with an open drain output rated at 18V. The SY28637F is available in an ultra-small DFN package and is fully specified over the temperature range of T_J=-40°C to 125°C.

Ordering Information

SY28637

└─ Package Code

└─ Optional Spec Code

Ordering Number	Package type	Note
SY28637FDTD	DFN1.45×1-6	--

Features

- Adjustable Threshold Down to 500mV
- Threshold Accuracy: 1% Over temperature
- Capacitor-adjustable Delay Time
- Low Quiescent Current: 9 μ A (typ.)
- External Enable Input
- Open Drain Output (Rated at 18V)
- Temperature Range: -40°C to 125°C
- Compact Package Minimizes Board Space: DFN1.45mm×1.0mm - 6

Applications

- DSPs, Microcontrollers, and Microprocessors
- Notebook and Desktop Computers
- PDAs and Handheld Products
- Portable and Battery-powered Products
- FPGAs and ASICs

Typical Applications

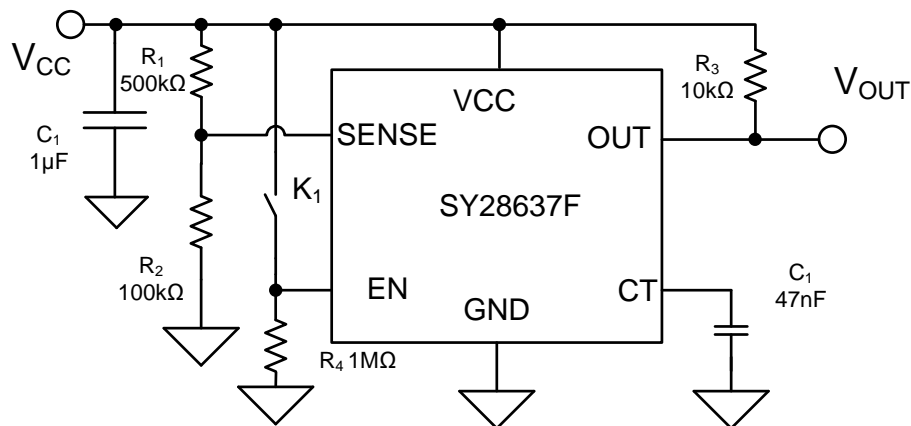
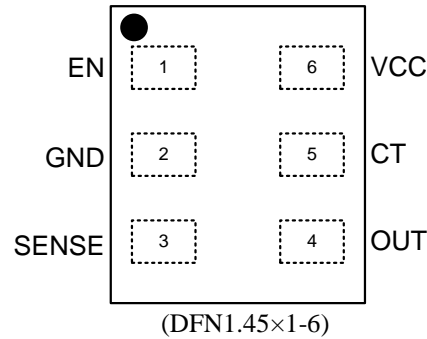


Figure1. Schematic Diagram

Pinout



Top Mark: txyz (device code: t, x=year code, y=week code, z= lot number code)

Pin Name	Pin NO.	I/O	Pin Description
CT	5	I	Capacitor-adjustable delay. The CT pin offers a user-adjustable delay time. Connecting this pin to a ground referenced capacitor sets the delay time for SENSE rising above 0.5V to OUT asserting. $t_{pd(r)}(s) = [C_{CT}(\mu F) \times 4] + 40\mu s$
EN	1	I	Active high input. Driving EN low immediately makes OUT go low, independent of V _{SENSE} . With V _{SENSE} already above V _{IT+} , drive EN high to make OUT go high after 0.2μs.
GND	2		Ground.
SENSE	3	I	This pin is connected to the voltage that is monitored with the use of an external resistor. The output asserts after the capacitor-adjustable delay time when V _{SENSE} rises above 0.5V and EN is asserted. The output de-asserts after a minimal propagation delay (16μs) when V _{SENSE} falls below V _{IT+} - V _{HYS} .
OUT	4	O	OUT is an open drain output that is immediately driven low after V _{SENSE} falls below (V _{IT+} - V _{HYS}) or the EN input is low. OUT goes high after the capacitor-adjustable delay time when V _{SENSE} is greater than V _{IT+} and the EN pin is high. Open drain device can be pulled up to 18V independent of VCC; Pull-up resistors are required for these devices.
VCC	6	I	Supply Voltage Input. Connect a 1.7V to 6.5V supply to VCC to power the device. It is good analog design practice to place a 0.1μF ceramic capacitor close to this pin.

Block Diagram

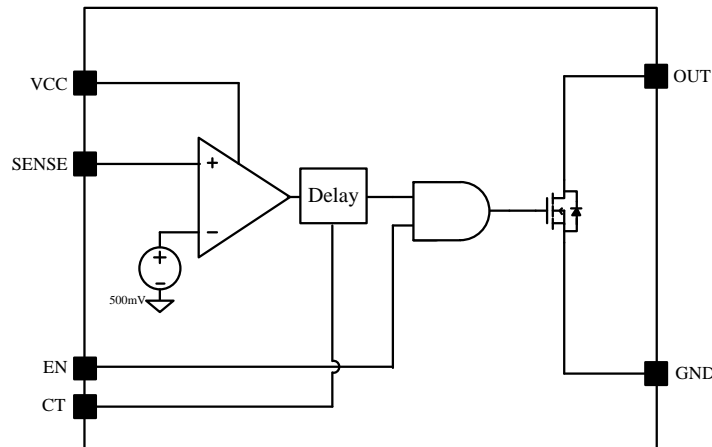


Figure2. Block Diagram

Absolute Maximum Ratings (Note 1)

VCC	-0.3V to 7V
CT	-0.3V to VCC + 0.3V
EN, SENSE	-0.3V to 7V
OUT (Open Drain)	-0.3V to 20V
OUT Current	±10mA
Power Dissipation, P _D @ T _A = 25°C	0.34W
Package Thermal Resistance (Note 2)	
θ _{JA}	293.8°C/W
θ _{JC}	165.1°C/W
Junction Temperature Range	-40°C to 125°C
Lead Temperature (Soldering, 10 sec.)	260°C
Storage Temperature Range	-65°C to 150°C

Recommended Operating Conditions (Note 3)

VCC	1.7V to 6.5V
CT	0V to 6.5V
EN, SENSE	0V to 6.5V
OUT (Open Drain)	0V to 18V
OUT Current	0.0003mA to 1mA

Electrical Characteristics

($T_J = -40^{\circ}\text{C}$ to 125°C , $1.7\text{V} < V_{CC} < 6.5\text{V}$, Typical values are at $T_J = 25^{\circ}\text{C}$ and $V_{CC} = 3.3\text{V}$, unless otherwise specified. The values are guaranteed by test, design or statistical correlation.)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Voltage Range	V_{CC}		1.7		6.5	V
Power on Reset Voltage	V_{POR}	$V_{OL} \text{ (max)} = 0.2\text{V}$, $I_{OUT} = 15\mu\text{A}$ (Note 4)		0.72		V
Supply Current (into VCC pin)	I_{CC}	$V_{CC}=3.3\text{V}$, $T_A=25^{\circ}\text{C}$, no load		9	12	μA
		$V_{CC}=3.3\text{V}$, $T_A=125^{\circ}\text{C}$, no load		12	14	μA
		$V_{CC}=6.5\text{V}$, $T_A=25^{\circ}\text{C}$, no load		11	13.5	μA
		$V_{CC}=6.5\text{V}$, $T_A=125^{\circ}\text{C}$, no load		14	16	μA
Positive-going Input Threshold Voltage	V_{IT+}	V_{SENSE} rising, $-40^{\circ}\text{C} < T_J < 125^{\circ}\text{C}$	0.495	0.5	0.505	V
Hysteresis Voltage	V_{HYS}	V_{SENSE} falling		5		mV
SENSE Input Current	I_{SENSE}	$V_{SENSE} = 0\text{V}$ to V_{CC} (Note 5)	-15		15	nA
CT Pin Charge Current	I_{CT}		260	310	360	nA
CT Pin Comparator Threshold Voltage	V_{CT}		1.18	1.238	1.299	V
CT Pin Down Resistance	R_{CT}			200		Ω
Low-level Input Voltage	V_{IL}				0.4	V
High-level Input Voltage	V_{IH}		1.4			V
Under Voltage Lockout	V_{UVLO}	V_{CC} falling, (Note 6)	1.3		1.7	V
EN Leakage		$EN/\#EN = V_{CC}$ or GND	-100		100	nA
Low-level Output Voltage	V_{OL}	$V_{CC} \geq 1.2\text{V}$, $I_{SINK} = 90\mu\text{A}$			0.3	V
		$V_{CC} \geq 2.25\text{V}$, $I_{SINK} = 0.5\text{mA}$			0.3	V
		$V_{CC} \geq 4.5\text{V}$, $I_{SINK} = 1\text{mA}$			0.4	V
Open-drain Output Leakage Current	$I_{LKG(OD)}$	V_{OUT} high impedance = 18V		20		nA

Timing Requirements

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
SENSE (rising) to OUT Propagation Delay	$t_{PD(r)}$	V_{SENSE} rising, $C_{CT} = \text{open}$		40		μs
		V_{SENSE} rising, $C_{CT} = 0.047\mu\text{F}$		190		ms
SENSE (falling) to OUT Propagation Delay	$t_{PD(f)}$	V_{SENSE} falling		16		μs
Start-up Delay		(Note 7)		50		μs
EN Pin Minimum Pulse Duration	t_W		1			μs
EN Glitch Rejection	t_{EN_GLH}			100		ns
EN to OUT Delay Time (Output Disable)	t_{d_off}	EN de-asserted to output de-asserted		200		ns
EN to VOUT Delay Time	t_{d_fix}	EN asserted to output asserted delay		200		ns

Note 1: Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: Θ_{JA} is measured in the natural convection at $T_A = 25^\circ\text{C}$ on a low effective single layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard.

Note 3: The device is not guaranteed to function outside its operating conditions

Note 4: The lowest supply voltage (V_{CC}) at which output is active (OUT is low); $t_{r-VCC} > 15\mu\text{s/V}$. below V_{POR} , the output cannot be determined.

Note 5: Specified by design.

Note 6: When V_{CC} falls below the UVLO threshold, the output de-asserts (OUT goes low). Below V_{POR} , the output cannot be determined

Note 7: During power on, V_{CC} must exceed 1.7 V for at least $50\mu\text{s}$ (plus propagation delay time, $t_{PD(r)}$) before output is in the correct state.

Sequence:

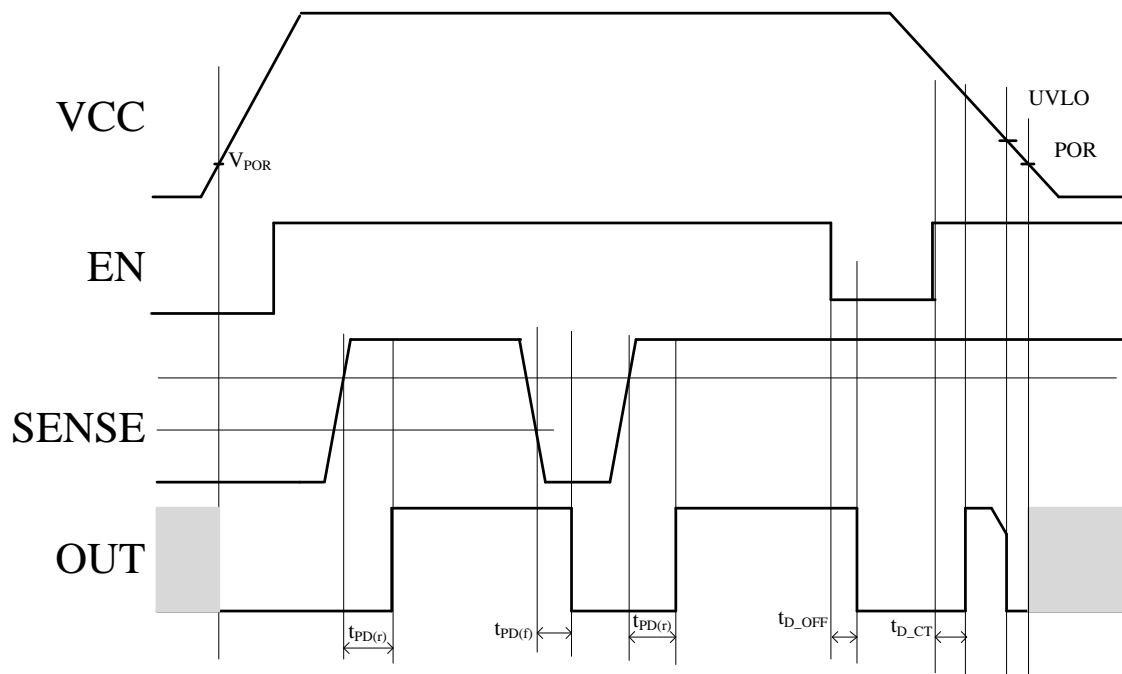
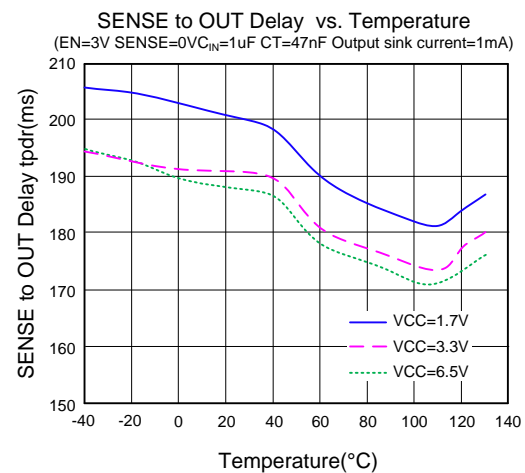
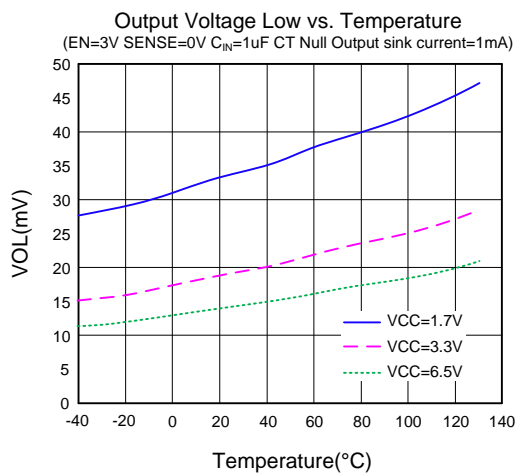
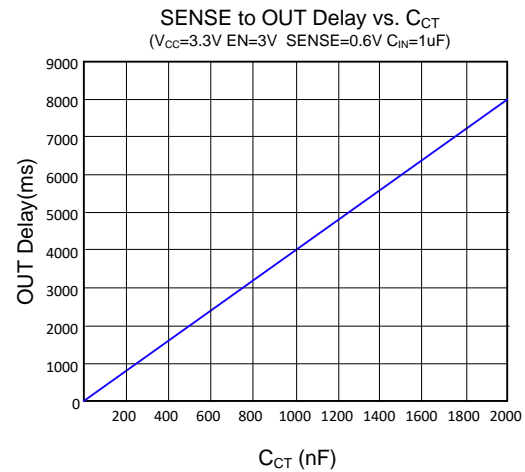
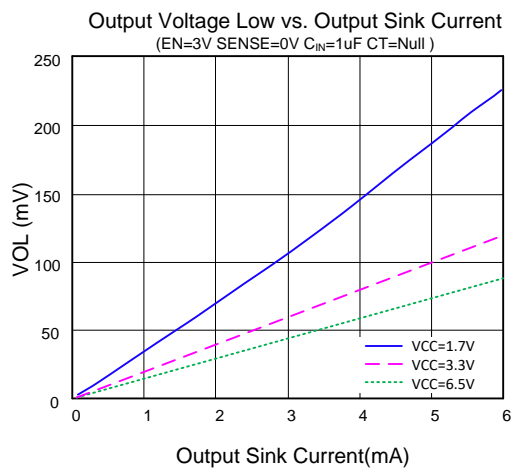
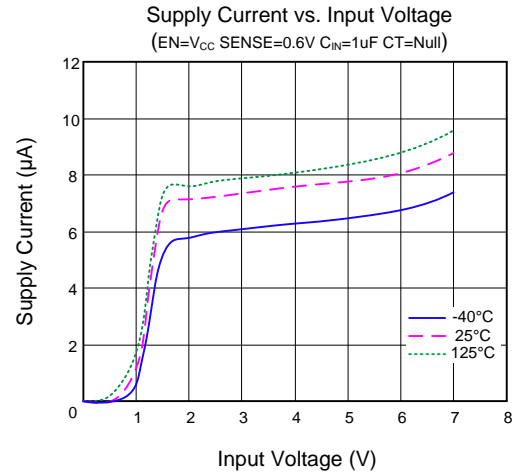
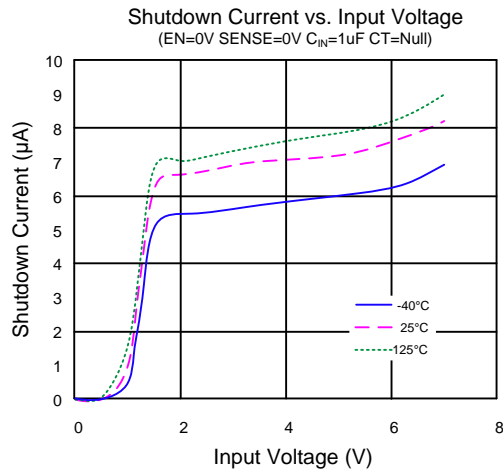
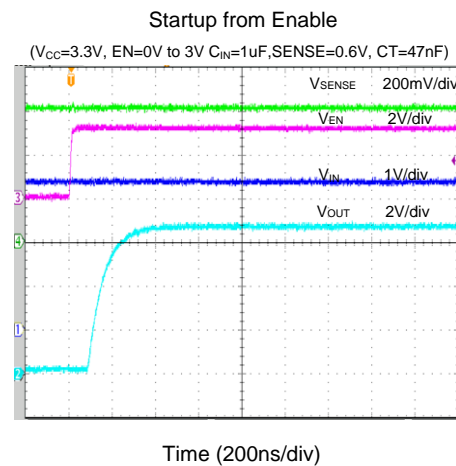
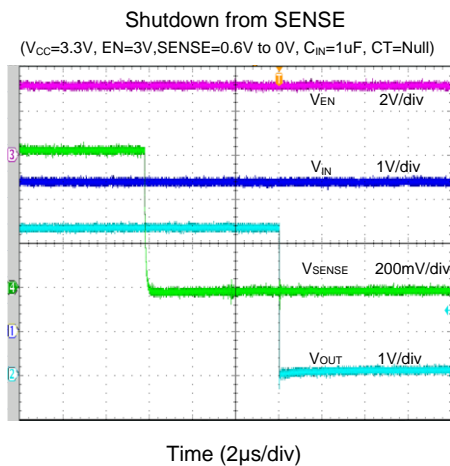
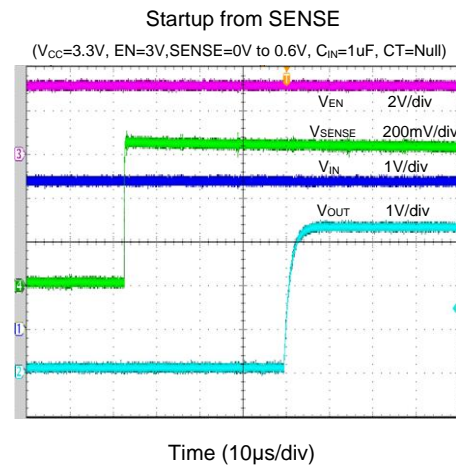
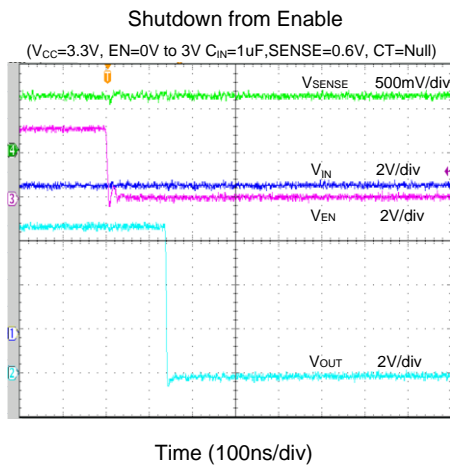
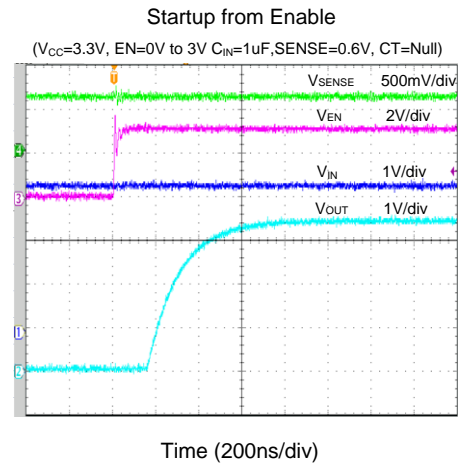
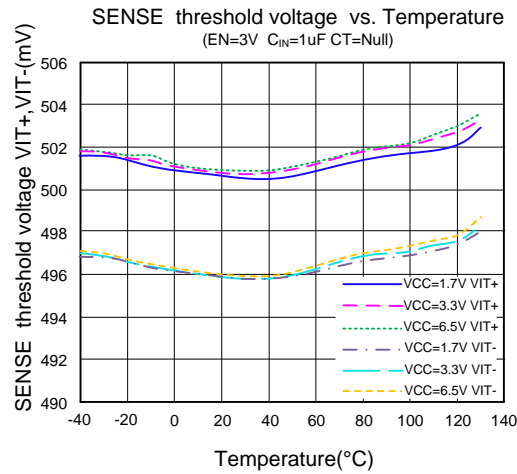


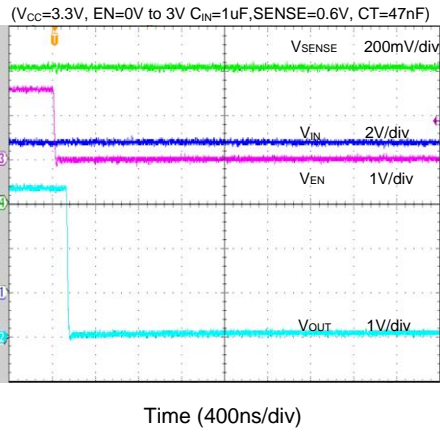
Figure3. SY28637F Sequence

Typical Operating Characteristics

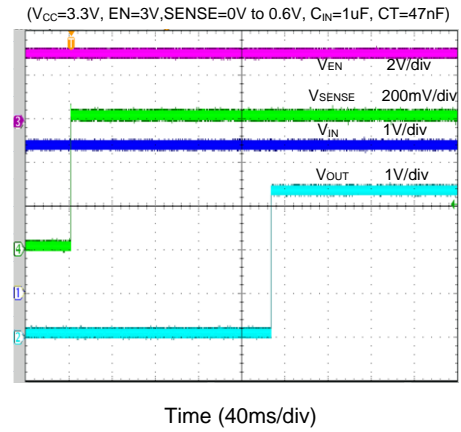




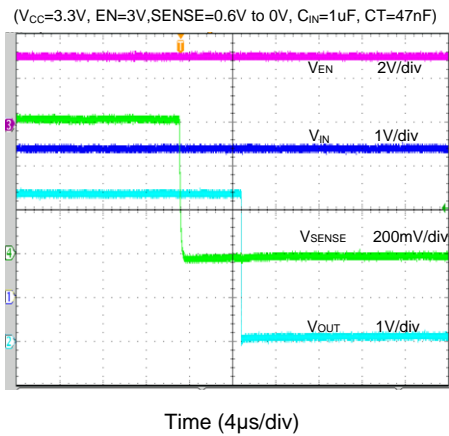
Shutdown from Enable



Startup from SENSE



Shutdown from SENSE



General Description

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The SY28637F operates from 1.7V to 6.5V and has a typical quiescent current of 9μA with an open drain output rated at 18V.

The SY28637F is available in an ultra-small DFN package and is fully specified over the temperature range of T_J=-40°C to 125°C.

Overview

The SY28637FDTD is an ultra-small supervisory circuit. The SY28637F is designed to assert the SENSE_OUT or SENSE_OUT signal, as shown in Table 1. When the SENSE pin rises above 0.5 V and the enable input is asserted (ENABLE = high or ENABLE = low), the output asserts (OUT goes high or OUT goes low) after the capacitor-adjustable delay time. The SENSE pin can be set to any voltage threshold above 0.5V using an external resistor divider. A broad range of output delay times and voltage thresholds can be supported, allowing these devices to be used in wide array of applications.

Table1. SY28637F Truth Table

Conditions		Output	Status
ENABLE = high	SENSE < VIT+	OUT = low	Output not asserted
ENABLE = low	SENSE < VIT+	OUT = low	Output not asserted
ENABLE = low	SENSE > VIT+	OUT = low	Output not asserted
ENABLE = high	SENSE > VIT+	OUT = high	Output asserted after delay

Applications Information

Input Pin (SENSE)

The SENSE input pin allows any system voltage above 0.5 V to be monitored. If the voltage at the SENSE pin exceeds VIT+, and provided that the enable pin is asserted (ENABLE=high), then the output is asserted after the capacitor-adjustable delay time elapses. When the voltage at the SENSE pin drops below (VIT+ -V_{hys}), the output is de-asserted. The comparator has a built-in hysteresis to ensure smooth output assertions and de-assertions. Although not required in most cases, for extremely noisy applications, it is good analog design practice to place a 1nF to 10nF bypass capacitor at the SENSE input in order to reduce sensitivity to transients and

layout parasitic. The target threshold voltage can be calculated by using Equation 1:

$$V_{TARGET} = (1 + R_1/R_2) \times 0.5(V) \quad (1)$$

Output Delay Time Pin (CT)

To program a user-defined, adjustable delay time, an external capacitor must be connected between the CT pin and GND. If the CT pin is left open, there will be a delay of 40μs. The adjustable delay time can be calculated through Equation 2:

$$t_{pd}(r) (s) = [CCT(\mu F) \times 4] + 40 \mu s \quad (2)$$

The reset delay time is determined by the time it takes an on-chip, precision 310nA current source to charge the external capacitor to 1.24 V. When SENSE > VIT+ and with ENABLE high, the internal current sources are enabled and begin to charge the external capacitors. When the CT voltage on a capacitor reaches 1.24 V, the corresponding OUT is asserted. Note that a low-leakage type capacitor (such as ceramic) should be used and that stray capacitance around this pin may cause errors in the reset delay time.

Output Pin (OUT)

In a typical SY28637F application, the OUT outputs is connected to a reset/enable input of the processor (DSP, CPU, FPGA, ASIC, and so on) or connected to the enable input of a voltage regulator. The SY28637F provide open-drain outputs. Pull up resistors must be used to hold these lines high when OUT is asserted. By connecting the pull up resistors to the proper voltage rails, OUT can be connected to other devices at the correct interface voltage levels. The outputs can be pulled up to 18 V independent of the supply voltage (VCC). To ensure proper voltage levels, some thought should be given to choosing the correct pull up resistor values. The ability to sink current is determined by the supply voltage; therefore, if VCC = 5V and the desired output pull up is 18 V, then to obtain a sink current of 1mA or less (as mentioned in the Electrical Characteristics), the pull up resistor value should be greater than 18kΩ. By using wired-OR logic, any combination of OUT can be merged into one logic signal.

Enable Function

The enable input allows an external logic signal from other processors, logic circuits, and/or discrete sensors to turn on or turn off the output. The SY28637FDTD offer an active-high enable input (ENABLE). Driving ENABLE high forces OUT to go high. The 0.4V (maximum) low and 1.4V (minimum) high allow ENABLE to be driven with a 1.5V or

greater system supply. Active high input. Driving EN low immediately makes OUT go low. With VSENSE already above VIT+, drive EN high to make OUT go high after 0.2 μ s.

PCB Layout Guide

For best performance of the SY28637F, the following guidelines must be strictly followed:

1. Place the VCC decoupling capacitor close to the device.

2. Input and output capacitors should be placed closed to the IC and connected to ground plane to reduce noise coupling.

3. SENSE pin is a sensitive pin. Keep SENSE trace far away from the trace or plane that has large dv/dt. The divider resistor should be placed as close as possible to the SENSE pin.

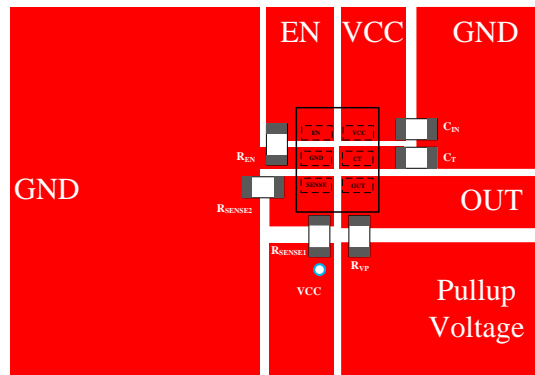
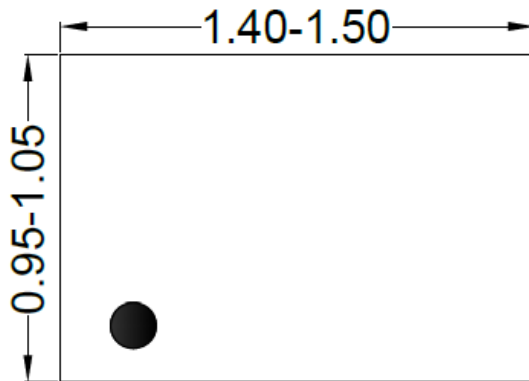
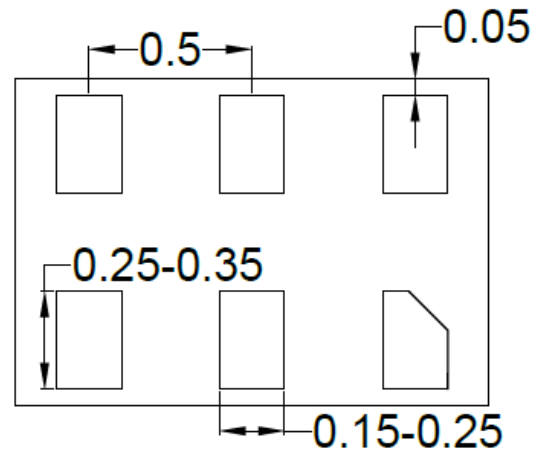


Figure4. PCB Layout Suggestion

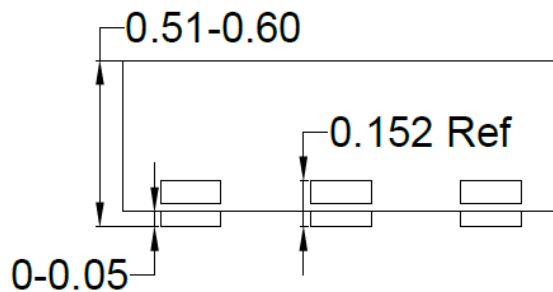
DFN1.45×1-6 Package Outline Drawing



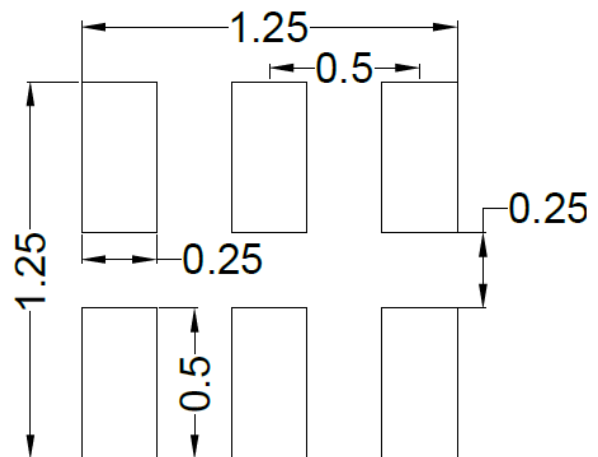
Top View



Bottom View



Side View

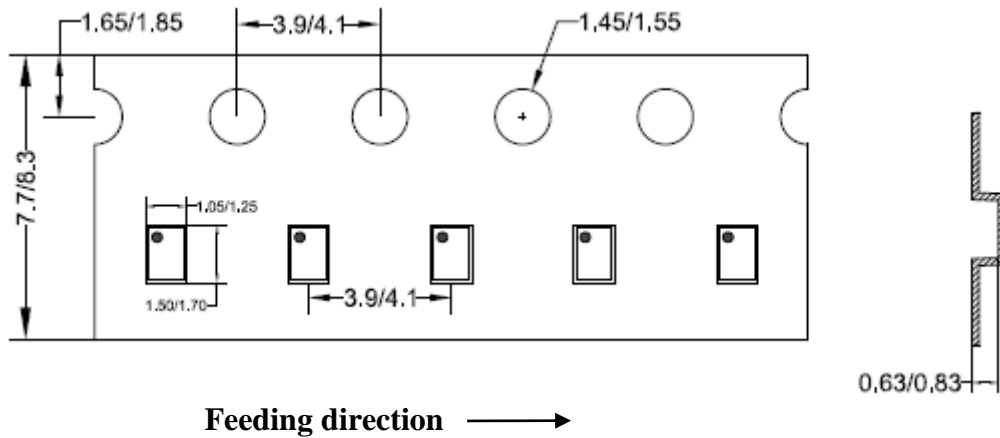


**Recommended PCB Layout
(only for reference)**

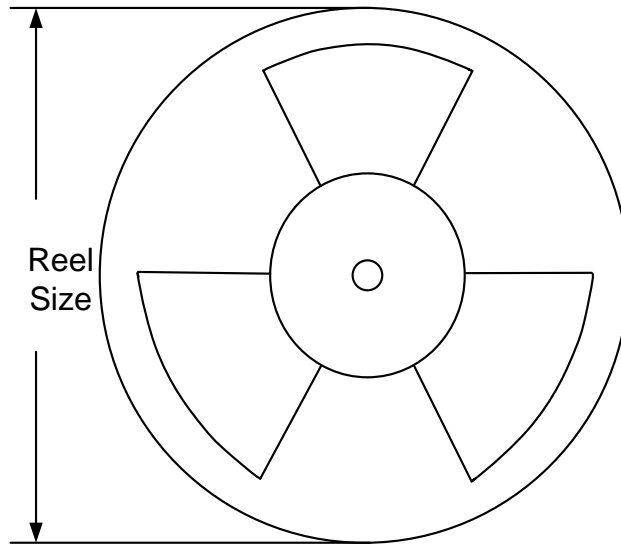
Notes: All dimension in millimeter and exclude mold flash & metal burr.

Taping & Reel Specification

1. Taping orientation



2. Carrier Tape & Reel specification for packages



Package types	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
DFN1.45×1	8	4	7"	400	160	3000

3. Others: NA



Revision History

The revision history provided is for informational purpose only and is believed to be accurate, however, not warranted. Please make sure that you have the latest revision.

Date	Revision	Change
Jan.04, 2022	Revision 0.9	Initial Release



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